

N-channel 30 V 18.1 mΩ logic level MOSFET in LFPAK33 using TrenchMOS Technology

4 September 2012

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Logic level enhancement mode N-channel MOSFET in LFPAK33 package. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

### **1.2 Features and benefits**

- Low parasitic inductance and resistance
- Optimised for 4.5V Gate drive utilising Superjunction technology
- Ultra low QG, QGD, and QOSS for high system efficiencies at low and high loads

### 1.3 Applications

- DC-to-DC converters
- Load switching
- Synchronous buck regulator

### 1.4 Quick reference data

Symbol	Parameter	Conditions	1	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	30	V
I <sub>D</sub>	drain current	T <sub>mb</sub> = 25 °C; V <sub>GS</sub> = 10 V; <u>Fig. 1</u>		-	-	31.8	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>		-	-	33	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics	· · · · · · · · · · · · · · · · · · ·					,
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 25 °C; Fig. 10		-	20.5	27	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	14.7	18.1	mΩ
Dynamic ch	naracteristics	· · · · · · · · · · · · · · · · · · ·					
Q <sub>GD</sub>	gate-drain charge	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 5 A; $V_{DS}$ = 15 V; Fig. 12; Fig. 13		-	1.7	-	nC
Q <sub>G(tot)</sub>	total gate charge	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 5 A; V <sub>DS</sub> = 15 V; Fig. 12; Fig. 13		-	4.6	-	nC

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### 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		D
2	S	source		
3	S	source	$\bigcirc$	G-UTA
4	G	gate		mbb076 S
mb	D	mounting base; connected to drain	LFPAK33 (SOT1210)	

### 3. Ordering information

Table 3. Ordering in	formation		
Type number	Package		
	Name	Description	Version
PSMN020-30MLC	LFPAK33	Plastic single ended surface mounted package (LFPAK33); 4 leads	SOT1210

### 4. Limiting values

#### Table 4.Limiting values

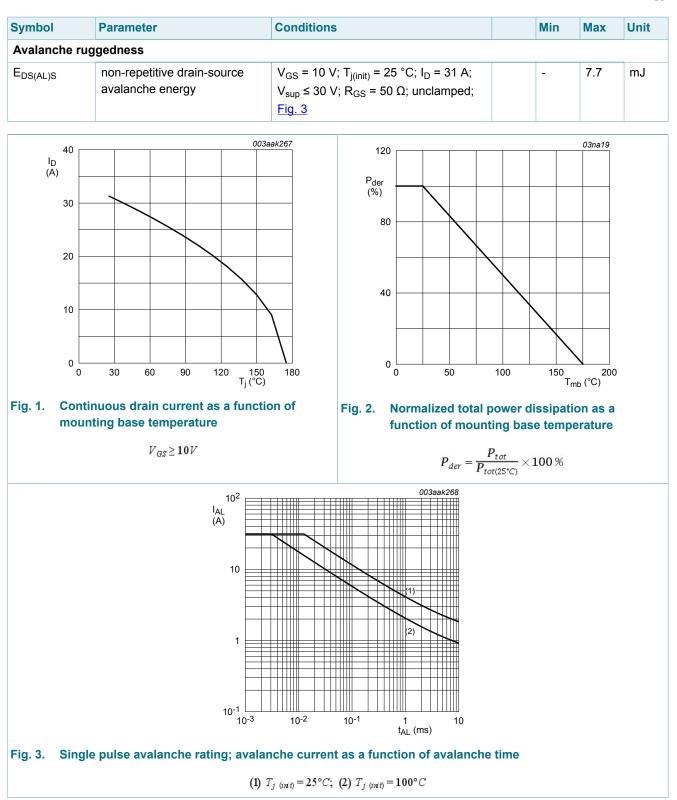
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C	-	30	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	31.8	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 1</u>	-	22.5	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^\circ C$ ; Fig. 4	-	127	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	33	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature		-	260	°C
V <sub>ESD</sub>	electrostatic discharge voltage	MM (JEDEC JESD22-A115)	130	-	V
Source-dra	in diode	· · · ·	I		
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	27.4	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu$ s; $T_{mb} = 25 \ ^\circ C$	-	127	Α

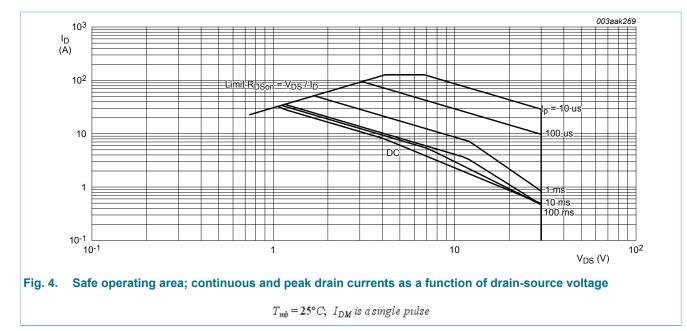
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### PSMN020-30MLC

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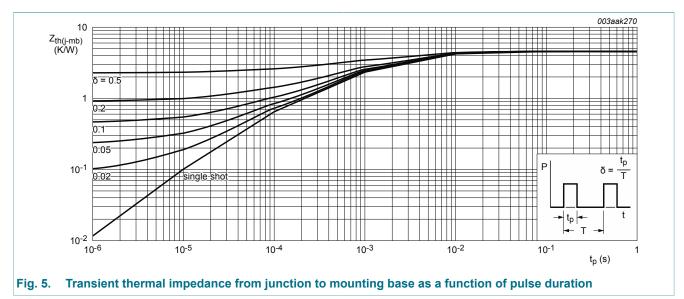


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### 5. Thermal characteristics

Table 5. The	rmal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. 5	-	4.32	4.56	K/W



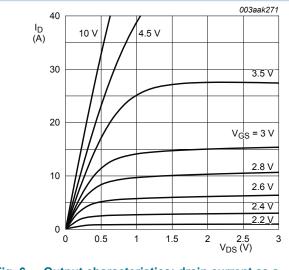
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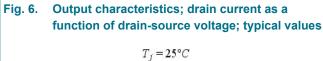
#### **Characteristics** 6.

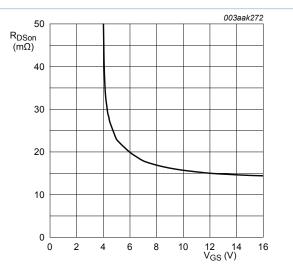
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$\begin{split} I_D &= 13.5 \text{ A};  \text{V}_{\text{GS}} = 0  \text{V};  \text{T}_{j(\text{init})} = 25 ^{\circ}\text{C}; \\ t_p &\leq 50  \mu\text{s} \end{split}$	34	-	-	V
		$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	30	-	-	V
		$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C	27	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	1.05	1.62	1.95	V
ΔV <sub>GS(th)</sub> /ΔT	gate-source threshold voltage variation with temperature		-	-3.5	-	mV/ł
DSS	drain leakage current	$V_{DS}$ = 30 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
		V <sub>DS</sub> = 30 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	100	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 16 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
		$V_{GS}$ = -16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 25 °C; Fig. 10	-	20.5	27	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 150 °C; Fig. 10; Fig. 11	-	-	43.2	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	14.7	18.1	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 5 A; T <sub>j</sub> = 150 °C; Fig. 10; Fig. 11	-	-	29	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz	0.68	1.37	2.74	Ω
Dynamic cha	racteristics	· · · · ·				
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 5 A; V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 10 V; Fig. 12; Fig. 13	-	9.5	-	nC
		I <sub>D</sub> = 5 A; V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 4.5 V; Fig. 12; Fig. 13	-	4.6	-	nC
		$I_D$ = 0 A; $V_{DS}$ = 0 V; $V_{GS}$ = 10 V	-	8.4	-	nC
$Q_{GS}$	gate-source charge	I <sub>D</sub> = 5 A; V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 4.5 V;	-	1	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge	Fig. 12; Fig. 13	-	0.3	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	0.7	-	nC
Q <sub>GD</sub>	gate-drain charge		-	1.7	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 5 A; V <sub>DS</sub> = 15 V; <u>Fig. 12; Fig. 13</u>	-	2.4	-	V

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 15 V; $V_{GS}$ = 0 V; f = 1 MHz;	-	430	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 14</u>	-	120	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	70	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 15 V; R <sub>L</sub> = 3 Ω; V <sub>GS</sub> = 4.5 V;	-	6.1	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$	-	7.2	-	ns
t <sub>d(off)</sub>	turn-off delay time	_	-	10.1	-	ns
t <sub>f</sub>	fall time		-	5.1	-	ns
Q <sub>oss</sub>	output charge	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 15 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	2.3	-	nC
Source-dr	ain diode					
V <sub>SD</sub>	source-drain voltage	$I_{S}$ = 5 A; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C; <u>Fig. 15</u>	-	0.89	1.1	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 5 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	13.5	-	ns
Qr	recovered charge	V <sub>DS</sub> = 15 V	-	5.1	-	nC
t <sub>a</sub>	reverse recovery rise time	$V_{GS}$ = 0 V; I <sub>S</sub> = 5 A; dI <sub>S</sub> /dt = -100 A/µs; V <sub>DS</sub> = 15 V; <u>Fig. 16</u>	-	6.3	-	ns
t <sub>b</sub>	reverse recovery fall time	-	-	7.2	-	ns



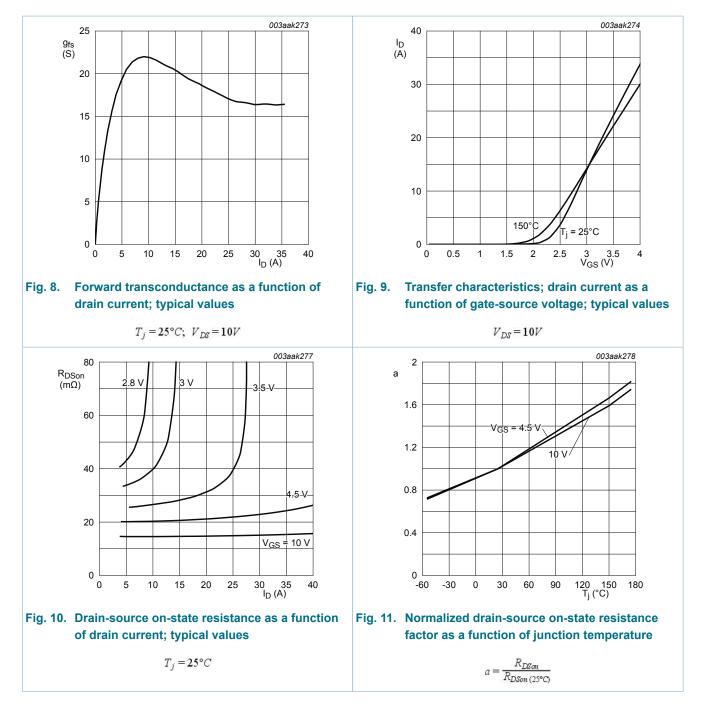






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T_j = 25^{\circ}C; I_D = 10A
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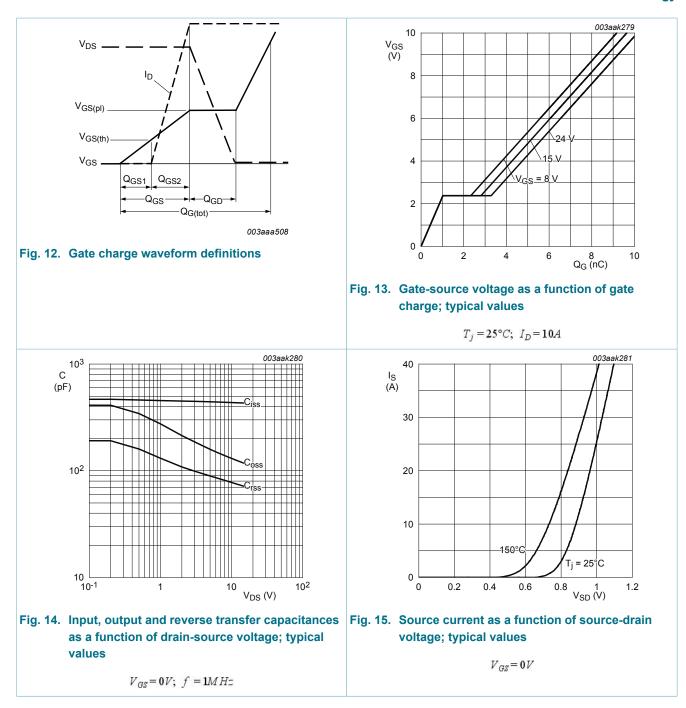
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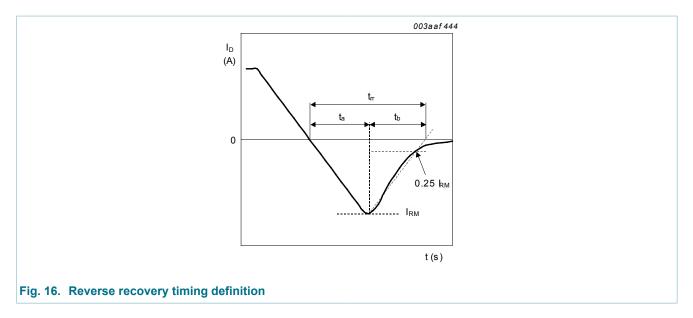
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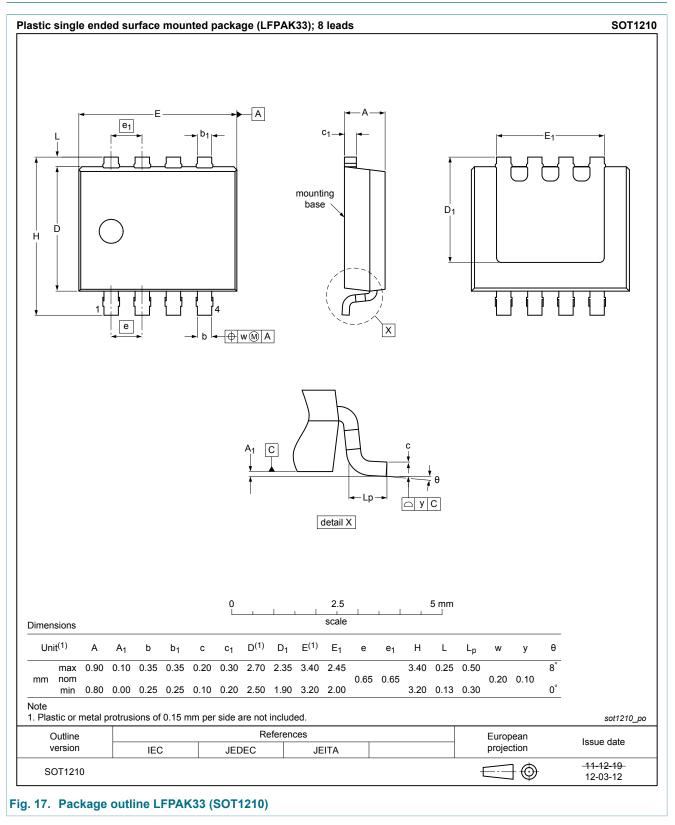
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#### N-channel 30 V 18.1 mΩ logic level MOSFET in LFPAK33 using TrenchMOS Technology

### 7. Package outline



PSMN020-30MLC

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